

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hung-Chuan Pai	07/22/2008
Shou-Fang Chen	07/22/2008
Chao-Tung Yang	07/22/2008
RECEIVING PARTY DATA	
Name:	MStar Semiconductor, Inc.
Street Address:	4F-1, Number 26, Tai-Yuan St. Chupei
City:	Hsinchu Hsien
State/Country:	TAIWAN
Postal Code:	302
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12143067
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NAME OF SUBMITTER:	Lawrence D. Eisen
Total Attachments: 1 source=Executed Assignment#page1.tif	

OP \$40.00 12143067

PATENT

ASSIGNMENT

For good and valuable consideration, We, Hung-Chuan Pai, Shou-Fang Chen, and Chao-Tung Yang, hereinafter individually or collectively referred to as "Assignor";

Hereby sell, assign and transfer to **MStar Semiconductor, Inc.**, having its principal place of business at 4F-1, Number 26, Tai-Yuan St. Chupei, Hsinchu Hsien, Taiwan 302, R.O.C., hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned and

filed on June 20, 2008 as US. Application Serial No. 12/143,067,

entitled: **FINGERPRINT SENSING CIRCUIT**

and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and legal representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or legal representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

SIGNATURE: Pai, Hung-Chuan DATE: Jul. 22, 2008
Hung-Chuan Pai

SIGNATURE: Shou-Fang Chen DATE: Jul. 22, 2008
Shou-Fang Chen

SIGNATURE: Chao-Tung Yang DATE: Jul. 22, 2008
Chao-Tung Yang